

SEARCHED

Class	Sub.	Date	Exmr.
438	108	11/7/02	

INTERFERENCE SEARCHED

Class	Sub.	Date	Exmr.

SEARCH NOTES
(INCLUDING SEARCH STRATEGY)

EAST 1.3	Date	Exmr.
APPLICANT CLAIMS A PROCESS OF FORMING A FLIP-CHIP WITH A MULTILAYERED SOLDER BALL HAVING A HIGH TEMP BALL AND A LOW TEMP BALL FOR TEMPORARY ATTACHMENT NOTE: CLASS/SUBCLASS SEARCH WAS BETTER THAN TEXT SEARCH	11/8/02	

(RIGHT OUTSIDE)